

**Vishay Siliconix** 

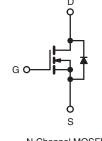
**RoH** 

COMPLIANT

### **Power MOSFET**

| PRODUCT SUMMARY            |                              |  |  |  |  |  |
|----------------------------|------------------------------|--|--|--|--|--|
| V <sub>DS</sub> (V)        | 100                          |  |  |  |  |  |
| R <sub>DS(on)</sub> (Ω)    | V <sub>GS</sub> = 10 V 0.077 |  |  |  |  |  |
| Q <sub>g</sub> (Max.) (nC) | 72                           |  |  |  |  |  |
| Q <sub>gs</sub> (nC)       | 11                           |  |  |  |  |  |
| Q <sub>gd</sub> (nC)       | 32                           |  |  |  |  |  |
| Configuration              | Single                       |  |  |  |  |  |





N-Channel MOSFET

#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION |            |
|----------------------|------------|
| Package              | TO-220AB   |
| Lead (Pb)-free       | IRF540PbF  |
|                      | SiHF540-E3 |
| SnPb                 | IRF540     |
|                      | SiHF540    |

| ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>         | - 20°0, uni             |                         |                                   |                  | · · · · · · · · · · · · · · · · · · · |  |
|--------------------------------------------------|-------------------------|-------------------------|-----------------------------------|------------------|---------------------------------------|--|
| PARAMETER                                        |                         |                         | SYMBOL                            | LIMIT            | UNIT                                  |  |
| Drain-Source Voltage                             |                         |                         | V <sub>DS</sub>                   | 100              | - v                                   |  |
| Gate-Source Voltage                              |                         |                         | V <sub>GS</sub>                   | ± 20             | v                                     |  |
| Continuous Drain Current                         | V <sub>GS</sub> at 10 V | T <sub>C</sub> = 25 °C  |                                   | 28               |                                       |  |
| Continuous Drain Current                         | VGS at TO V             | $T_{C} = 100 ^{\circ}C$ | I <sub>D</sub>                    | 20               | А                                     |  |
| Pulsed Drain Current <sup>a</sup>                |                         |                         | I <sub>DM</sub>                   | 110              |                                       |  |
| Linear Derating Factor                           |                         |                         |                                   | 1.0              | W/°C                                  |  |
| Single Pulse Avalanche Energy <sup>b</sup>       |                         |                         | E <sub>AS</sub>                   | 230              | mJ                                    |  |
| Repetitive Avalanche Current <sup>a</sup>        |                         |                         | I <sub>AR</sub>                   | 28               | A                                     |  |
| Repetitive Avalanche Energy <sup>a</sup>         |                         |                         | E <sub>AR</sub>                   | 15               | mJ                                    |  |
| Maximum Power Dissipation                        | T <sub>C</sub> =        | 25 °C                   | PD                                | 150              | W                                     |  |
| Peak Diode Recovery dV/dt <sup>c</sup>           |                         |                         | dV/dt                             | 5.5              | V/ns                                  |  |
| Operating Junction and Storage Temperature Range |                         |                         | T <sub>J</sub> , T <sub>stg</sub> | - 55 to + 175    | °C                                    |  |
| Soldering Recommendations (Peak Temperature)     | for 10 s                |                         |                                   | 300 <sup>d</sup> | ]                                     |  |
| Mounting Torque                                  | 6-32 or M3 screw        |                         |                                   | 10               | lbf ∙ in                              |  |
| Mounting Torque                                  |                         |                         |                                   | 1.1              | N · m                                 |  |

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ ,  $L = 440 \text{ }\mu\text{H}$ ,  $R_g = 25 \Omega$ ,  $I_{AS} = 28 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 28$  A, dl/dt  $\le 170$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11 www.vishay.com

### Vishay Siliconix



| THERMAL RESISTANCE RATI                          | NGS                 |                                                                                                                                                                                                                                                               |                                              |                                      |            |           |                      |                  |
|--------------------------------------------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------|--------------------------------------|------------|-----------|----------------------|------------------|
| PARAMETER                                        | SYMBOL              | TYP.                                                                                                                                                                                                                                                          |                                              | MAX.                                 |            |           | UNIT                 |                  |
| Maximum Junction-to-Ambient                      | R <sub>thJA</sub>   | -                                                                                                                                                                                                                                                             |                                              | 62                                   |            |           |                      |                  |
| Case-to-Sink, Flat, Greased Surface              | R <sub>thCS</sub>   | 0.50                                                                                                                                                                                                                                                          |                                              | -                                    |            |           | °C/W                 |                  |
| Maximum Junction-to-Case (Drain)                 | R <sub>thJC</sub>   | -                                                                                                                                                                                                                                                             |                                              | 1.0                                  |            | 1         |                      |                  |
| <b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u | nless otherw        | ise noted)                                                                                                                                                                                                                                                    |                                              |                                      |            |           |                      |                  |
| PARAMETER                                        | SYMBOL              | 1                                                                                                                                                                                                                                                             | CONDIT                                       | IONS                                 | MIN.       | TYP.      | MAX.                 | UNIT             |
| Static                                           | 0111201             |                                                                                                                                                                                                                                                               |                                              |                                      |            |           | 110 0 11             | •                |
| Drain-Source Breakdown Voltage                   | V <sub>DS</sub>     | $V_{CS} = 0$                                                                                                                                                                                                                                                  | ) V, I <sub>D</sub> = 2                      | 250 uA                               | 100        | -         | -                    | v                |
| V <sub>DS</sub> Temperature Coefficient          | $\Delta V_{DS}/T_J$ | Reference                                                                                                                                                                                                                                                     |                                              | •                                    | _          | 0.13      | _                    | V/°C             |
| Gate-Source Threshold Voltage                    | V <sub>GS(th)</sub> |                                                                                                                                                                                                                                                               | / <sub>GS</sub> , I <sub>D</sub> = 2         |                                      | 2.0        | -         | 4.0                  | V                |
| Gate-Source Leakage                              | I <sub>GSS</sub>    |                                                                                                                                                                                                                                                               | $a_{s} = \pm 20$                             |                                      | _          | _         | ± 100                | nA               |
|                                                  |                     | 1                                                                                                                                                                                                                                                             |                                              |                                      | _          | -         | 25                   |                  |
| Zero Gate Voltage Drain Current                  | I <sub>DSS</sub>    | $V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 \text{ °C}$                                                                                                                                                                         |                                              | _                                    | 250        | μA        |                      |                  |
| Drain-Source On-State Resistance                 | R <sub>DS(on)</sub> | -                                                                                                                                                                                                                                                             |                                              | I <sub>D</sub> = 17 A <sup>b</sup>   | -          | -         | 0.077                | Ω                |
| Forward Transconductance                         | 9 <sub>fs</sub>     | $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 17 \text{ A}^{b}$                                                                                                                                                                                                     |                                              | 8.7                                  | -          | _         | S                    |                  |
| Dynamic                                          |                     |                                                                                                                                                                                                                                                               |                                              |                                      | L          | L         |                      |                  |
| Input Capacitance                                | C <sub>iss</sub>    | V                                                                                                                                                                                                                                                             | / <sub>GS</sub> = 0 V                        | 3                                    | -          | 1700      | -                    |                  |
| Output Capacitance                               | C <sub>oss</sub>    | V <sub>DS</sub> = 25 V,<br>f = 1.0 MHz, see fig. 5                                                                                                                                                                                                            |                                              | -                                    | 560        | -         | pF                   |                  |
| Reverse Transfer Capacitance                     | C <sub>rss</sub>    |                                                                                                                                                                                                                                                               |                                              | -                                    | 120        | -         |                      |                  |
| Total Gate Charge                                | Qg                  |                                                                                                                                                                                                                                                               |                                              | -                                    | -          | -         | 72                   |                  |
| Gate-Source Charge                               | Q <sub>gs</sub>     | V <sub>GS</sub> = 10 V                                                                                                                                                                                                                                        | $I_D = 17 \text{ A}, V_{DS} = 80 \text{ V},$ |                                      | -          | -         | 11                   | nC               |
| Gate-Drain Charge                                | Q <sub>gd</sub>     | -                                                                                                                                                                                                                                                             | see                                          | see fig. 6 and 13 <sup>b</sup>       |            | -         | 32                   |                  |
| Turn-On Delay Time                               | t <sub>d(on)</sub>  |                                                                                                                                                                                                                                                               |                                              |                                      | -          | 11        | -                    |                  |
| Rise Time                                        | t <sub>r</sub>      | $\begin{array}{c c} & - & & \\ & & - & \\ & & & \\ & & V_{DD} = 50 \text{ V}, \text{ I}_{D} = 17 \text{ A} & - & \\ & & & \\ & & & R_{g} = 9.1 \ \Omega, \text{ R}_{D} = 2.9 \ \Omega, \text{ see fig. } 10^{\text{b}} & \\ & & - & \\ & & & - & \end{array}$ |                                              | -                                    | 44         | -         | - ns                 |                  |
| Turn-Off Delay Time                              | t <sub>d(off)</sub> |                                                                                                                                                                                                                                                               |                                              | -                                    | 53         | -         |                      |                  |
| Fall Time                                        | t <sub>f</sub>      |                                                                                                                                                                                                                                                               |                                              | -                                    | 43         | -         |                      |                  |
| Internal Drain Inductance                        | L <sub>D</sub>      | Between lead,<br>6 mm (0.25") fro                                                                                                                                                                                                                             | m                                            |                                      | -          | 4.5       | -                    |                  |
| Internal Source Inductance                       | Ls                  | package and center of die contact                                                                                                                                                                                                                             |                                              | -                                    | 7.5        | -         | nH                   |                  |
| Drain-Source Body Diode Characteristic           | cs                  |                                                                                                                                                                                                                                                               |                                              |                                      |            |           |                      |                  |
| Continuous Source-Drain Diode Current            | I <sub>S</sub>      | MOSFET symbol<br>showing the<br>integral reverse<br>p - n junction diode                                                                                                                                                                                      |                                              | -                                    | -          | 28        | _                    |                  |
| Pulsed Diode Forward Current <sup>a</sup>        | I <sub>SM</sub>     |                                                                                                                                                                                                                                                               |                                              | -                                    | -          | 110       | A                    |                  |
| Body Diode Voltage                               | V <sub>SD</sub>     | T <sub>J</sub> = 25 °C, I                                                                                                                                                                                                                                     | <sub>S</sub> = 28 A                          | , V <sub>GS</sub> = 0 V <sup>b</sup> | -          | -         | 2.5                  | V                |
| Body Diode Reverse Recovery Time                 | t <sub>rr</sub>     | T <sub>J</sub> = 25 °C, I <sub>F</sub> =                                                                                                                                                                                                                      | اہم 17.۸                                     | /dt - 100 ^ /uch                     | -          | 180       | 360                  | ns               |
| Body Diode Reverse Recovery Charge               | Q <sub>rr</sub>     | 1 J = 23 C, I <sub>F</sub> =                                                                                                                                                                                                                                  | 17 A, dl/                                    |                                      | -          | 1.3       | 2.8                  | μC               |
| Forward Turn-On Time                             | t <sub>on</sub>     | Intrinsic turn-                                                                                                                                                                                                                                               | on time                                      | is negligible (turn                  | -on is dor | minated b | y L <sub>S</sub> and | L <sub>D</sub> ) |

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

www.vishay.com 2 Document Number: 91021 S11-0510-Rev. B, 21-Mar-11



**Vishay Siliconix** 



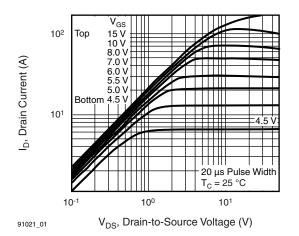


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

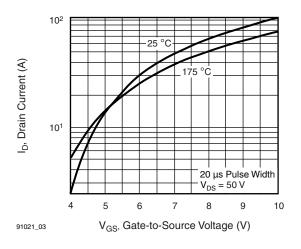


Fig. 3 - Typical Transfer Characteristics

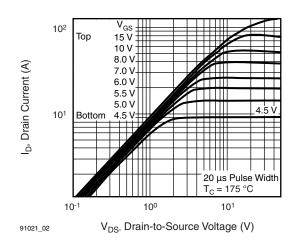


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175 °C

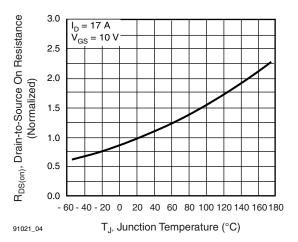


Fig. 4 - Normalized On-Resistance vs. Temperature

Vishay Siliconix



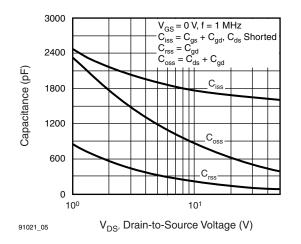


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

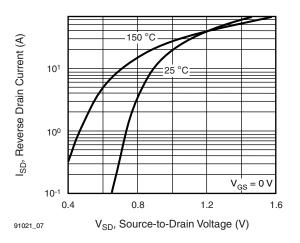


Fig. 7 - Typical Source-Drain Diode Forward Voltage

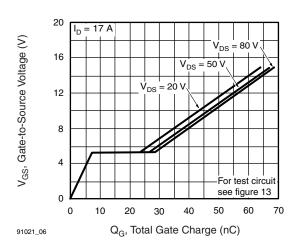


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

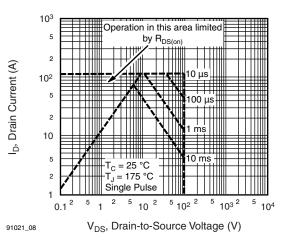


Fig. 8 - Maximum Safe Operating Area

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11



### **Vishay Siliconix**

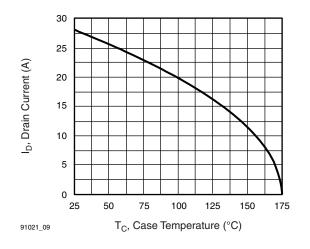


Fig. 9 - Maximum Drain Current vs. Case Temperature

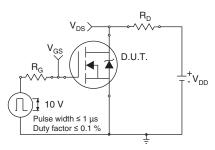


Fig. 10a - Switching Time Test Circuit

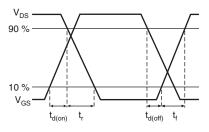


Fig. 10b - Switching Time Waveforms

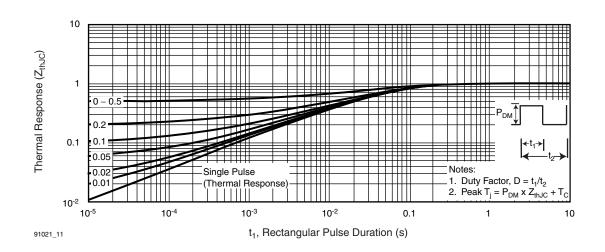


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

### Vishay Siliconix



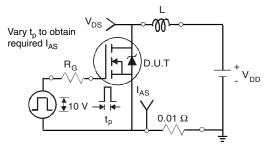


Fig. 12a - Unclamped Inductive Test Circuit

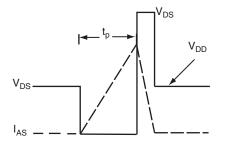


Fig. 12b - Unclamped Inductive Waveforms

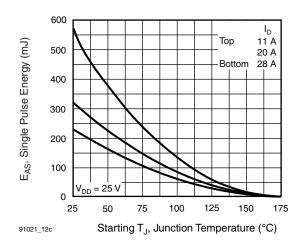


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

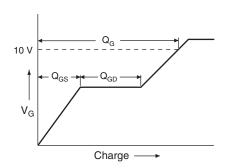


Fig. 13a - Basic Gate Charge Waveform

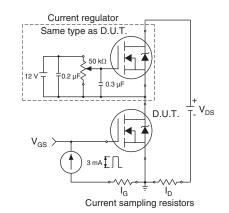
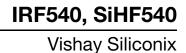


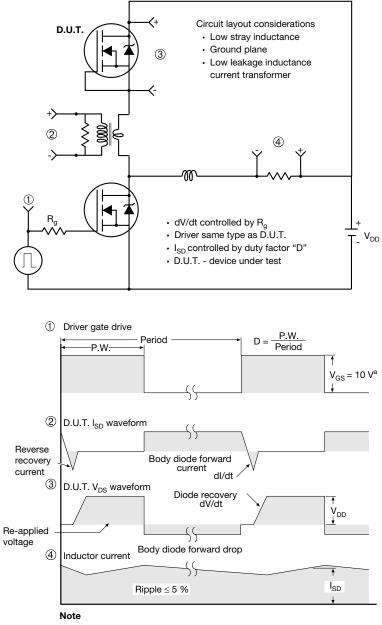
Fig. 13b - Gate Charge Test Circuit

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11





#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91021">http://www.vishay.com/ppg?91021</a>.

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11 www.vishay.com

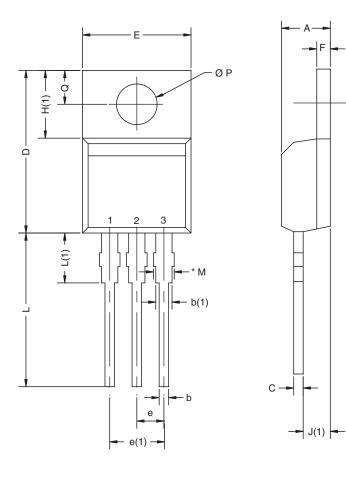
<sup>7</sup> 



# **Package Information**

Vishay Siliconix

### TO-220AB



|      | MILLIMETERS  |       | INC   | CHES  |  |
|------|--------------|-------|-------|-------|--|
| DIM. | MIN.         | MAX.  | MIN.  | MAX.  |  |
| А    | 4.25         | 4.65  | 0.167 | 0.183 |  |
| b    | 0.69         | 1.01  | 0.027 | 0.040 |  |
| b(1) | 1.20         | 1.73  | 0.047 | 0.068 |  |
| С    | 0.36         | 0.61  | 0.014 | 0.024 |  |
| D    | 14.85        | 15.49 | 0.585 | 0.610 |  |
| Е    | 10.04        | 10.51 | 0.395 | 0.414 |  |
| е    | 2.41         | 2.67  | 0.095 | 0.105 |  |
| e(1) | 4.88         | 5.28  | 0.192 | 0.208 |  |
| F    | 1.14         | 1.40  | 0.045 | 0.055 |  |
| H(1) | 6.09         | 6.48  | 0.240 | 0.255 |  |
| J(1) | 2.41         | 2.92  | 0.095 | 0.115 |  |
| L    | 13.35        | 14.02 | 0.526 | 0.552 |  |
| L(1) | 3.32         | 3.82  | 0.131 | 0.150 |  |
| ØΡ   | 3.54         | 3.94  | 0.139 | 0.155 |  |
| Q    | 2.60         | 3.00  | 0.102 | 0.118 |  |
|      | 0416-Rev. M, |       | 0.102 | 0.11  |  |

#### Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.